



# Product Change Notification

## 112475 - 00

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# Product Change Notification

**Change Notification #:** 112475 - 00  
**Change Title:** Intel® Server System R2208GZ4GC  
PCN 112475-00, Product Design  
Update Rear Panel, Add Ground Studs  
**Date of Publication:** August 09, 2013

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

* <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Aug 24, 2013
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\* *Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R2208GZ4GC:

1. Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Adding two ground studs on the system rear panel for future use. See Figure 1 below:



Figure 1: The ground studs

**Customer Impact of Change and Recommended Action:**

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

**Products Affected / Intel Ordering Codes:**

EMEA SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R2208GZ4GC	917001	G52125-005	G52125-006

**PCN Revision History:****Date of Revision:**

August 9, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN